



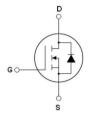
N-Channel Super Junction Power MOSFET

General Description

The series of devices use advanced super junction technology and design to provide excellent $R_{DS(ON)}$ with low gate charge. This super junction MOSFET fits the industry's AC-DC SMPS requirements for PFC, AC/DC power conversion, and industrial power applications.

Features

- ◆ New technology for high voltage device
- ◆ Low on-resistance and low conduction losses
- ◆ Small package
- ◆ Ultra Low Gate Charge cause lower driving requirements
- ◆ 100% Avalanche Tested
- ROHS compliant





Schematic diagram

TO-263

Application

- ◆ Power factor correction (PFC)
- Switched mode power supplies(SMPS)
- ◆ Uninterruptible Power Supply (UPS)

Vos	650	V
R _{DS(ON)MAX}	1200	mΩ
I _D	4	А

Package Marking And Ordering Information

Device	Device Package	Marking
MJ65R1K2D	TO-263	MJ65R1K2D

Table 1. Absolute Maximum Ratings (Tc=25℃)

Parameter	Symbol	MJ65R1K2D	Unit
Drain-Source Voltage (Vcs=0V)	VDS	650	V
Gate-Source Voltage (Vps=0V)	Vgs	±30	V
Continuous Drain Current at Tc=25°C	ID (DC)	4	А
Continuous Drain Current at Tc=100°C	ID (DC)	2.5	А
Pulsed drain current (Note 1)	IDM (pluse)	12	Α
Maximum Power Dissipation (Tc=25°C)	Po	46	W
Derate above 25°C	PD	0.37	W/°C
Single pulse avalanche energy (Note 2)	Eas	130	mJ
Avalanche current (Note 1)	lar	2	А
Repetitive Avalanche energy , t_{AR} limited by T_{jmax} (Note 1)	Ear	0.2	mJ

Parameter	Symbol	MJ65R1K2D	Unit
Drain Source voltage slope, V _{DS} ≤480 V	dv/dt	50	V/ns
Reverse diode dv/dt, Vps ≤480 V,lsp <lp< td=""><td>dv/dt</td><td>15</td><td>V/ns</td></lp<>	dv/dt	15	V/ns
Operating Junction and Storage Temperature Range	Т _Ј ,Тѕтс	-55+150	°C





Table 2. Thermal Characteristic

Parameter	Symbol	Value	Unit
Thermal Resistance, Junction-to-Case (Maximum)	RthJC	2.7	°C/W
Thermal Resistance, Junction-to-Ambient (Maximum)	RthJA	62	°C/W

Table 3. Electrical Characteristics (T_A=25℃ unless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Unit	
On/off states							
Drain-Source Breakdown Voltage	BVoss	V _{GS} =0V I _D =250μA	650	-	-	V	
Zero Gate Voltage Drain Current (Tc=25°C)	loss	V _{DS} =650V,V _{GS} =0V	-	_	1	μΑ	
Zero Gate Voltage Drain Current (Tc=125℃)	loss	V _{DS} =650V,V _{GS} =0V	-	-	50	μΑ	
Gate-Body Leakage Current	lgss	V _{GS} =±30V,V _{DS} =0V	-	-	±100	nA	
Gate Threshold Voltage	V _{GS(th)}	V _{DS} =V _{GS} ,I _D =250μA	2.5	3	3.5	V	
Drain-Source On-State Resistance	RDS(ON)	V _{GS} =10V,I _D =2.5A	-	1000	1200	mΩ	
Dynamic Characteristics							
Forward Transconductance	g FS	V _{DS} =20V,I _D =2.5A	-	4	-	S	
Input Capacitance	Cies		-	280	-	PF	
Output Capacitance	Coss	V _{DS} =50V,V _{GS} =0V F=1.0MHz	-	26	-	PF	
Reverse Transfer Capacitance	Crss		-	2.3	-	PF	
Total Gate Charge	Qg		-	6.5	10	nC	
Gate-Source Charge	Qgs	V _{DS} =480V,I _D =4A V _{GS} =10V	-	1.3	-	nC	
Gate-Drain Charge	Qgd	-	-	2.5	-	nC	
Intrinsic gate resistance	Rg	f=1 MHz open drain	-	2.5	-	Ω	
Switching times							
Turn-on Delay Time	t _{d(on)}		-	6	-	nS	
Turn-on Rise Time	tr	Vpp=380V,Ip=2.5A	-	3	-	nS	
Turn-Off Delay Time	t _{d(off)}	R _G =20Ω,V _{GS} =10V	-	48	60	nS	
Turn-Off Fall Time	tr	-	-	8	15	nS	
Source- Drain Diode Characteristics						ı	
Source-drain current (Body Diode)	Isp		-	_	4	А	
Pulsed Source-drain current (Body Diode)	Isdm	- Tc=25°C	-	-	12	А	
Forward On Voltage	Vsp	Tj=25°C,IsD=4A,Vgs=0V	-	1	1.3	V	
Reverse Recovery Time	trr		-	150	-	nS	
Reverse Recovery Charge	Qrr	Tj=25°C,I⊧=4A di/dt=100A/µs	-	0.85	-	uC	
Peak reverse recovery current	Irrm		-	11	-	А	

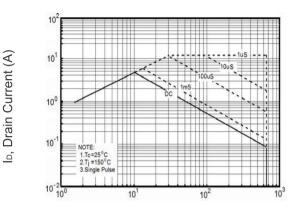




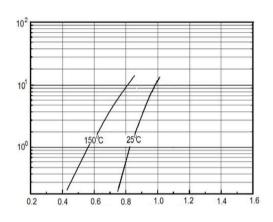
Notes

- 1.Repetitive Rating: Pulse width limited by maximum junction temperature
- $2.T_j = 25^{\circ}C, V_{DD} = 50V, V_{G} = 10V, R_{G} = 25\Omega$

TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS (curves)



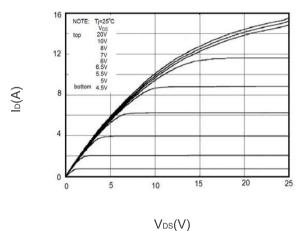
lpr, Reverse Drain Current(A)



V_{DS}, Drain-Source Voltage (V)

Figure 1 Safe operating area

V_{SD},Source-Drain Voltage(V) Figure 2 Source-Drain Diode Forward Voltage



lb, Drain Current (A)

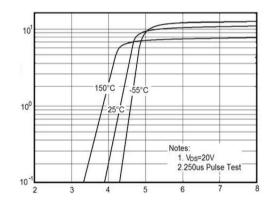
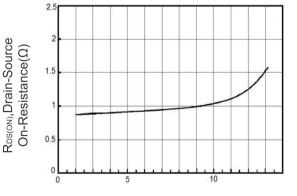
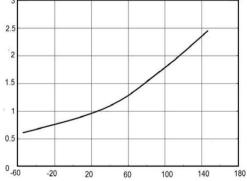


Figure 3 Output characteristics

V_{GS}, Gate-Source Voltage (V) Figure 4 Transfer characteristics



ADS(ON), Drain-Source On-Resistance(Ω)



ID, Drain Current (A)

Figure 5 Static drain-source on resistance

T_J, Junction Temperature (°C) Figure 6 RDS(ON) vs Junction Temperature

lb, Drain Current (A)

Capacitances(pF)



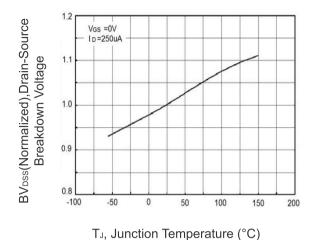
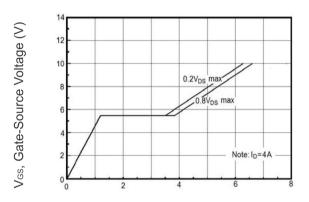
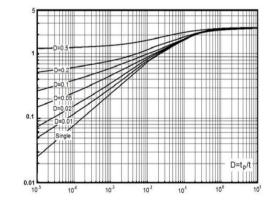


Figure 7 BV_{DSS} vs Junction Temperature



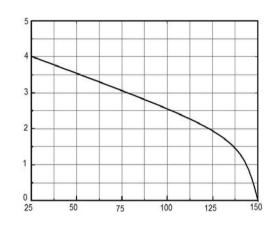
Q_G,Total Gate Charge(nC)
Figure 9 Gate charge waveforms



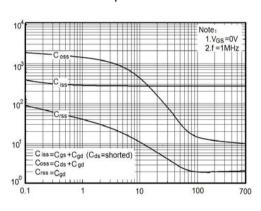
Zthuc, Thermal Respone

tp,Square Wave Pulse(S)

Figure 11 Transient Thermal Impedance



Tc, Case Temperature (°C)
Figure 8 Maximum Ib vs Junction
Temperature



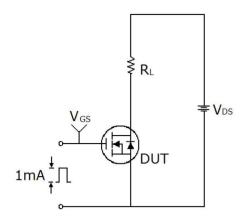
V_{DS}, Drain-Source Voltage (V)

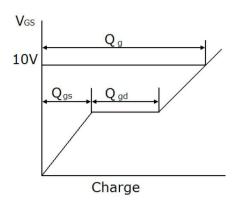
Figure 10 Capacitance



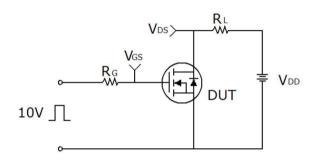


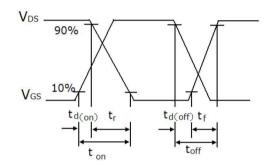
Test circuit



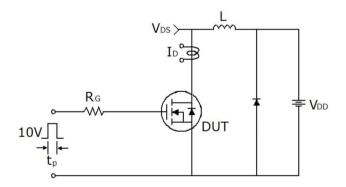


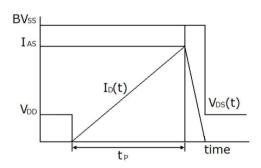
Gate charge test circuit & Waveform





Switch Time Test Circuit



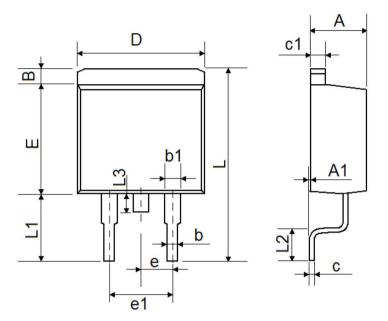


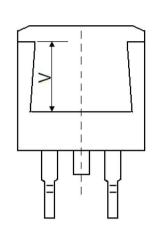
Unclamped Inductive Switching Test Circuit & Waveforms





TO-263-2L Package Information





Cymrh ol	Dimensions In Millimeters		Dimensions In Inches		
Symbol	Min.	Max.	Min.	Max.	
A	4.470	4.670	0.176	0.184	
A1	0.000	0.150	0.000	0.006	
В	1.170	1.370	0.046	0.054	
b	0.710	0.910	0.028	0.036	
b1	1.170	1.370	0.046	0.054	
С	0.310	0.530	0.012	0.021	
c1	1.170	1.370	0.046	0.054	
D	10.010	10.310	0.394	0.406	
E	8.500	8.900	0.335	0.350	
е	2.540 TYP.		0.100 TYP.		
e1	4.980	5.180	0.196	0.204	
L	15.050	15.450	0.593	0.608	
L1	5.080	5.480	0.200	0.216	
L2	2.340	2.740	0.092	0.108	
L3	1.300	1.700	0.051	0.067	
V	5.600	REF	0.220 REF		





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